

S-13D1 Series

5.5 V INPUT, 150 mA, 2-CIRCUIT VOLTAGE REGULATOR WITH DELAY FUNCTION

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Rev.1.4_00

The S-13D1 Series, developed by using the CMOS technology, is a 2-channel positive voltage regulator IC which has low dropout voltage, high accuracy output voltage and low current consumption.

A 0.22 μ F small ceramic capacitor can be used, and the S-13D1 Series includes a load current protection circuit that prevents the output current from exceeding the current capacity of the output transistor and a thermal shutdown circuit that prevents damage due to overheating. Also, C / F type in the S-13D1 Series has a built-in delay function that sets the difference of rising time between channels.

Features

Output voltage:	1.0 V to 3.6 V, selectable in 0.05 V step		
Input voltage:	1.5 V to 5.5 V		
Output voltage accuracy:	±1.0% (1.0 V to 1.45 V output product : ±15 mV)		
Dropout voltage:	80 mV typ. (2.8 V output product, $I_{OUT} = 100$ mA)		
Current consumption:	During operation: 39 µA typ., 58 µA max. (per circuit)		
·	During power-off: 0.1 µA typ., 1.0 µA max.		
Output current:	Possible to output 150 mA ($V_{IN} \ge V_{OUT(S)} + 1.0 \text{ V}$) ^{*1} (per circuit)		
 Input and output capacitors: 	A ceramic capacitor of 0.22 μ F or more can be used.		
Ripple rejection:	70 dB typ. (3.6 V output product, $f = 1.0 \text{ kHz}$)		
Delay function is selectable.			
Built-in overcurrent protection circuit:	Limits overcurrent of output transistor.		
Built-in thermal shutdown circuit:	Prevents damage caused by heat.		
Built-in ON / OFF circuit:	Ensures long battery life		
	Discharge shunt function "available" / "unavailable" is selectable.		
	Pull-down function "available" / "unavailable" is selectable.		
Operation temperature range:	$Ta = -40^{\circ}C \text{ to } +85^{\circ}C$		
a Lood from (Sn 100%) hologon from			

• Lead-free (Sn 100%), halogen-free

*1. Attention should be paid to the power dissipation of the package when the output current is large.

Applications

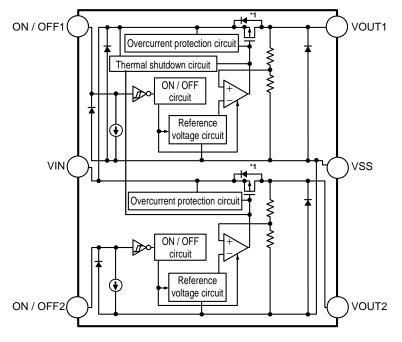
- Constant-voltage power supply for digital camera
- Constant-voltage power supply for mobile phone
- Constant-voltage power supply for portable equipment

Packages

- SOT-23-6
- HSNT-6 (1212)

Block Diagrams

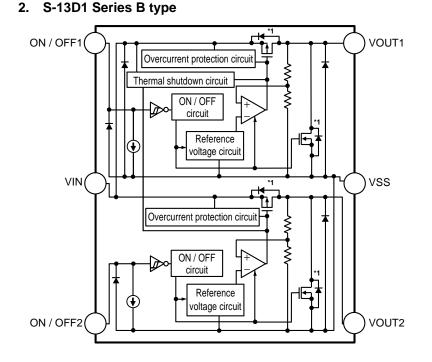
1. S-13D1 Series A type



Function	Status
ON / OFF logic	Active "H"
Discharge shunt function	Unavailable
Constant current source pull-down	Available
Delay function	Unavailable

*1. Parasitic diode

Figure 1



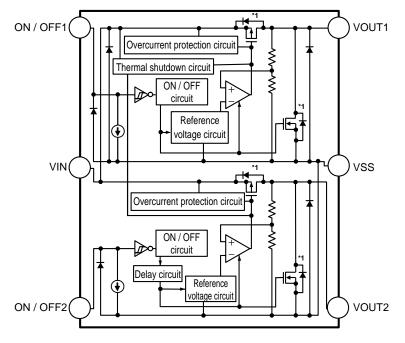
Function	Status
ON / OFF logic	Active "H"
Discharge shunt function	Available
Constant current source pull-down	Available
Delay function	Unavailable

*1. Parasitic diode

Figure 2

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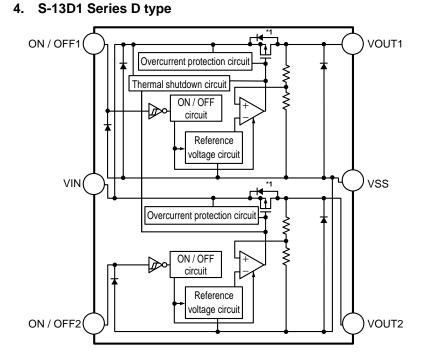
3. S-13D1 Series C type



Function	Status
ON / OFF logic	Active "H"
Discharge shunt function	Available
Constant current source pull-down	Available
Delay function	Available

*1. Parasitic diode



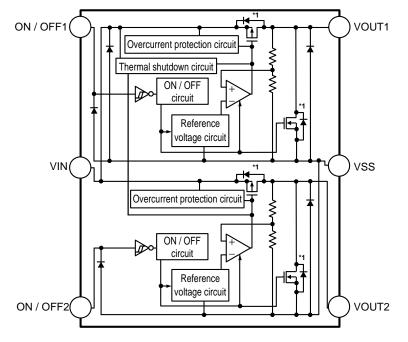


Function	Status
ON / OFF logic	Active "H"
Discharge shunt function	Unavailable
Constant current source pull-down	Unavailable
Delay function	Unavailable

*1. Parasitic diode

Figure 4

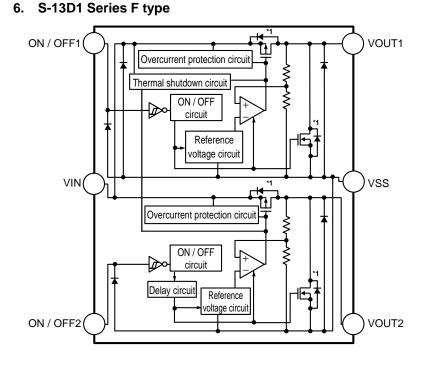
5. S-13D1 Series E type



Function	Status	
ON / OFF logic	Active "H"	
Discharge shunt function	Available	
Constant current source pull-down	Unavailable	
Delay function	Unavailable	

*1. Parasitic diode





Function	Status
ON / OFF logic	Active "H"
Discharge shunt function	Available
Constant current source pull-down	Unavailable
Delay function	Available

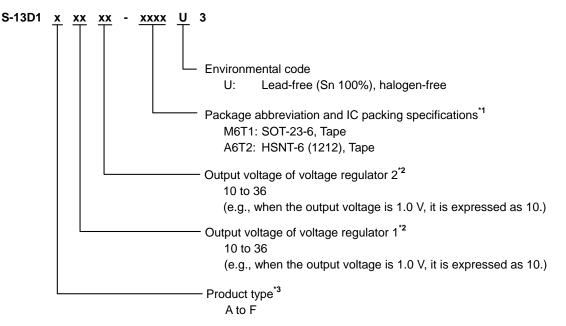
*1. Parasitic diode

Figure 6

Product Name Structure

Users can select the product type, output voltage, and package type for the S-13D1 Series. Refer to "1. Product name" regarding the contents of product name, "2. Function list of product types" regarding the product type, "3. Packages" regarding the package drawings, "4. Product name list" regarding details of the product name.

1. Product name



- ***1.** Refer to the tape drawing.
- *2. If you request the product which has 0.05 V step, contact our sales office.
- *3. Refer to "2. Function list of product types".

2. Function list of product types

Table 1				
Product Type	ON / OFF Logic	Discharge Shunt Function	Constant Current Source Pull-down	Delay Function
А	Active "H"	Unavailable	Available	Unavailable
В	Active "H"	Available	Available	Unavailable
С	Active "H"	Available	Available	Available
D	Active "H"	Unavailable	Unavailable	Unavailable
E	Active "H"	Available	Unavailable	Unavailable
F	Active "H"	Available	Unavailable	Available

3. Packages

Table 2 Package Drawing	a Codes
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Package Name	Dimension	Tape	Reel	Land
SOT-23-6	MP006-A-P-SD	MP006-A-C-SD	MP006-A-R-SD	_
HSNT-6 (1212)	PM006-A-P-SD	PM006-A-C-SD	PM006-A-R-SD	PM006-A-L-SD

4. Product name list

4.1 S-13D1 Series B type

ON / OFF logic: Constant current source pull-down: Active "H" Available

Discharge shunt function: Delay function: Available Unavailable

Available Available

Table 3				
Voltage Regulator 1 Output Voltage	Voltage Regulator 2 Output Voltage	SOT-23-6	HSNT-6 (1212)	
$1.2 \text{ V} \pm 15 \text{ mV}$	1.8 V ± 1.0%	S-13D1B1218-M6T1U3	S-13D1B1218-A6T2U3	
1.5 V ± 1.0%	2.8 V ± 1.0%	S-13D1B1528-M6T1U3	S-13D1B1528-A6T2U3	
1.8 V ± 1.0%	$1.2 \text{ V} \pm 15 \text{ mV}$	S-13D1B1812-M6T1U3	S-13D1B1812-A6T2U3	
1.8 V ± 1.0%	1.5 V ± 1.0%	S-13D1B1815-M6T1U3	S-13D1B1815-A6T2U3	
1.8 V ± 1.0%	1.8 V ± 1.0%	S-13D1B1818-M6T1U3	S-13D1B1818-A6T2U3	
1.8 V ± 1.0%	2.8 V ± 1.0%	S-13D1B1828-M6T1U3	S-13D1B1828-A6T2U3	
1.8 V ± 1.0%	$3.3 \text{ V} \pm 1.0\%$	S-13D1B1833-M6T1U3	S-13D1B1833-A6T2U3	
2.5 V ± 1.0%	1.8 V ± 1.0%	S-13D1B2518-M6T1U3	S-13D1B2518-A6T2U3	
2.8 V ± 1.0%	1.8 V ± 1.0%	S-13D1B2818-M6T1U3	S-13D1B2818-A6T2U3	
2.8 V ± 1.0%	2.8 V ± 1.0%	S-13D1B2828-M6T1U3	S-13D1B2828-A6T2U3	
2.8 V ± 1.0%	3.3 V ± 1.0%	S-13D1B2833-M6T1U3	S-13D1B2833-A6T2U3	
2.85 V ± 1.0%	$2.85 \text{ V} \pm 1.0\%$	S-13D1B2J2J-M6T1U3	S-13D1B2J2J-A6T2U3	
3.0 V ± 1.0%	1.8 V ± 1.0%	S-13D1B3018-M6T1U3	S-13D1B3018-A6T2U3	
3.1 V ± 1.0%	3.0 V ± 1.0%	S-13D1B3130-M6T1U3	S-13D1B3130-A6T2U3	
3.3 V ± 1.0%	3.0 V ± 1.0%	S-13D1B3330-M6T1U3	S-13D1B3330-A6T2U3	
3.3 V ± 1.0%	$3.3~\text{V}\pm1.0\%$	S-13D1B3333-M6T1U3	S-13D1B3333-A6T2U3	

Remark Please contact our sales office for products with specifications other than the above.

4.2 S-13D1 Series C type

ON / OFF logic:	Active "H"	Discharge shunt function:
Constant current source pull-down:	Available	Delay function:

Table 4						
Voltage Regulator 1 Output Voltage	Voltage Regulator 2 Output Voltage	SOT-23-6	HSNT-6 (1212)			
$1.2 \text{ V} \pm 15 \text{ mV}$	$1.8 \text{ V} \pm 1.0\%$	S-13D1C1218-M6T1U3	S-13D1C1218-A6T2U3			
$1.5 \text{ V} \pm 1.0\%$	$2.8 \text{ V} \pm 1.0\%$	S-13D1C1528-M6T1U3	S-13D1C1528-A6T2U3			
$1.8 \text{ V} \pm 1.0\%$	$1.8 \text{ V} \pm 1.0\%$	S-13D1C1818-M6T1U3	S-13D1C1818-A6T2U3			
$1.8~\text{V}\pm1.0\%$	$2.8 \text{ V} \pm 1.0\%$	S-13D1C1828-M6T1U3	S-13D1C1828-A6T2U3			
$1.8 \text{ V} \pm 1.0\%$	$3.3 \text{ V} \pm 1.0\%$	S-13D1C1833-M6T1U3	S-13D1C1833-A6T2U3			
$2.8 \text{ V} \pm 1.0\%$	$2.8 \text{ V} \pm 1.0\%$	S-13D1C2828-M6T1U3	S-13D1C2828-A6T2U3			
$2.8 \text{ V} \pm 1.0\%$	$3.3 \text{ V} \pm 1.0\%$	S-13D1C2833-M6T1U3	S-13D1C2833-A6T2U3			
2.85 V ± 1.0%	$2.85 \text{ V} \pm 1.0\%$	S-13D1C2J2J-M6T1U3	S-13D1C2J2J-A6T2U3			
$3.6 \text{ V} \pm 1.0\%$	3.6 V ± 1.0%	S-13D1C3636-M6T1U3	S-13D1C3636-A6T2U3			

Remark Please contact our sales office for products with specifications other than the above.

4.3 S-13D1 Series D type

ON / OFF logic:

Constant current source pull-down:

Active "H" wn: Unavailable Discharge shunt function: Delay function: Unavailable Unavailable

Table 5

Voltage Regulator 1 Output Voltage	Voltage Regulator 2 Output Voltage	SOT-23-6	HSNT-6 (1212)
$1.2 \text{ V} \pm 15 \text{ mV}$	1.8 V ± 1.0%	S-13D1D1218-M6T1U3	S-13D1D1218-A6T2U3
1.5 V ± 1.0%	2.8 V ± 1.0%	S-13D1D1528-M6T1U3	S-13D1D1528-A6T2U3
1.8 V ± 1.0%	1.8 V ± 1.0%	S-13D1D1818-M6T1U3	S-13D1D1818-A6T2U3
1.8 V ± 1.0%	2.8 V ± 1.0%	S-13D1D1828-M6T1U3	S-13D1D1828-A6T2U3
1.8 V ± 1.0%	3.3 V ± 1.0%	S-13D1D1833-M6T1U3	S-13D1D1833-A6T2U3
2.8 V ± 1.0%	2.8 V ± 1.0%	S-13D1D2828-M6T1U3	S-13D1D2828-A6T2U3
2.8 V ± 1.0%	3.3 V ± 1.0%	S-13D1D2833-M6T1U3	S-13D1D2833-A6T2U3
2.85 V ± 1.0%	2.85 V ± 1.0%	S-13D1D2J2J-M6T1U3	S-13D1D2J2J-A6T2U3

Remark Please contact our sales office for products with specifications other than the above.

Pin Configurations

1. SOT-23-6

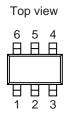
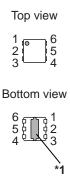


Table 6					
Pin No.	Symbol	Description			
1	ON / OFF1	ON / OFF 1 pin			
2	VIN	Input voltage pin			
3	ON / OFF2	ON / OFF 2 pin			
4	VOUT2	Output voltage 2 pin			
5	VSS	GND pin			
6	VOUT1	Output voltage 1 pin			

Figure 7

2. HSNT-6 (1212)



-	Table 7					
	Pin No.	Symbol	Description			
	1	VOUT1	Output voltage 1 pin			
	2	VOUT2	Output voltage 2 pin			
	3	VSS	GND pin			
	4	ON / OFF2	ON / OFF 2 pin			
	5	VIN	Input voltage pin			
	6	ON / OFF1	ON / OFF 1 pin			
	0					

Figure 8

*1. Connect the heat sink of backside at shadowed area to the board, and set electric potential GND. However, do not use it as the function of electrode.

Absolute Maximum Ratings

		Table	28	
			(Ta = +25°C unless oth	erwise specified)
Iter	n	Symbol	Absolute Maximum Rating	Unit
		V _{IN}	$V_{SS} - 0.3$ to $V_{SS} + 6.0$	V
Input voltage		$V_{ON/OFF1}, V_{ON/OFF2}$	$V_{SS} - 0.3$ to $V_{SS} + 6.0$	V
Output voltage		V _{OUT1} , V _{OUT2}	$V_{SS} - 0.3$ to $V_{IN} + 0.3$	V
Output current		I _{OUT1} , I _{OUT2}	200	mA
Device disation ation	SOT-23-6	D	650 ^{*1}	mW
Power dissipation	HSNT-6 (1212)	P _D	480 ^{*1}	mW
Operation ambient temperature		T _{opr}	-40 to +85	°C
Storage temperature		T _{stg}	-40 to +125	°C

*1. When mounted on board

[Mounted board]

(1) Board size: 114.3 mm \times 76.2 mm \times t1.6 mm

(2) Name: JEDEC STANDARD51-7

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

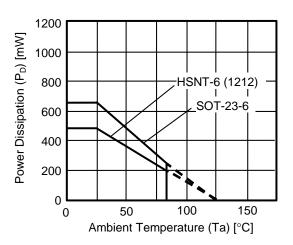


Figure 9 Power Dissipation of Package (When Mounted on Board)

Power Dissipation of HSNT-6 (1212) (Reference)

Power dissipation of package differs depending on the mounting conditions. Consider the power dissipation characteristics under the following conditions as reference.

[Mounted board]

- 40 mm \times 40 mm \times t0.8 mm
- (2) Board material: Glass epoxy resin (four layers)

50%

- (3) Wiring ratio:
- (4) Test conditions: When mounted on board (wind speed: 0 m/s)
- (5) Land pattern:

(1) Board size:

- When mounted on board (who speed, 0 m/s)
- Refer to the recommended land pattern (drawing code: PM006-A-L-SD)

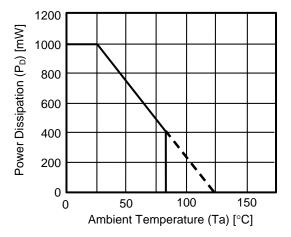


Figure 10 Power Dissipation of Package (When Mounted on Board)

	Table 9	
Condition	Power Dissipation (Reference)	Thermal Resistance Value (θj–a)
HSNT-6 (1212) (When mounted on board)	1000 mW	100°C/W

5.5 V INPUT, 150 mA, 2-CIRCUIT VOLTAGE REGULATOR WITH DELAY FUNCTION Rev.1.4_00 S-13D1 Series

■ Electrical Characteristics (per Circuit)

				(Ta = +	25°C unl	ess othei	wise sp	ecified)
Item	Symbol	Со	ndition	Min.	Тур.	Max.	Unit	Test Circuit
Output voltage ^{*1}	V _{OUT(E)}	$V_{\text{IN}} = V_{\text{OUT}(S)} + 1.0 \text{ V},$	$1.0 \text{ V} \leq \text{V}_{\text{OUT}(\text{S})} < 1.5 \text{ V}$	$\begin{array}{c} V_{\text{OUT(S)}} \\ - \ 0.015 \end{array}$	V _{OUT(S)}	V _{OUT(S)} + 0.015	V	1, 2
	VOUT(E)	I _{OUT} = 30 mA	$1.5~V \leq V_{OUT(S)} \leq 3.6~V$	$V_{OUT(S)} \times 0.99$	V _{OUT(S)}	$V_{OUT(S)} \times 1.01$	V	1, 2
Output current ^{*2}	I _{OUT}	$V_{IN} \geq V_{OUT(S)} + 1.0 \ V$	1	150 ^{*5}	-	-	mA	4, 5
			$1.0 \text{ V} \leq \text{V}_{\text{OUT(S)}} < 1.1 \text{ V}$	0.5	0.52	0.54	V	1, 2
			$1.1 \text{ V} \le \text{V}_{\text{OUT(S)}} < 1.2 \text{ V}$	-	0.42	0.44	V	1, 2
			$1.2 \text{ V} \le \text{V}_{\text{OUT(S)}} < 1.3 \text{ V}$	-	0.32	0.34	V	1, 2
			$1.3 \text{ V} \le \text{V}_{\text{OUT(S)}} < 1.4 \text{ V}$	-	0.22	0.24	V	1, 2
Dropout voltage ^{*3}	V _{drop}	I _{OUT} = 100 mA	$1.4 \text{ V} \le \text{V}_{\text{OUT(S)}} < 1.5 \text{ V}$	-	0.15	0.22	V	1, 2
	arop		$1.5 V \le V_{OUT(S)} < 1.7 V$	-	0.14	0.21	V	1,2
			$1.7 \text{ V} \le \text{V}_{\text{OUT}(S)} < 2.1 \text{ V}$	-	0.12	0.19	V	1,2
			$2.1 \text{ V} \le \text{V}_{\text{OUT(S)}} < 2.5 \text{ V}$	_	0.10	0.16	V	1,2
			$2.5 V \le V_{OUT(S)} < 2.8 V$	_	0.09	0.14	V V	1, 2 1, 2
Line regulation	$\frac{\Delta V_{OUT1}}{\Delta V_{IN} \bullet V_{OUT}}$	$V_{OUT(S)} + 0.5 \ V \leq V_{IN}$	$2.8 \text{ V} \le \text{V}_{\text{OUT(S)}} \le 3.6 \text{ V}$ $\le 5.5 \text{ V}, \text{ I}_{\text{OUT}} = 30 \text{ mA}$	-	0.08	0.13 0.2	%/V	1, 2
Load regulation	ΔV_{OUT2}	$\label{eq:VIN} \begin{split} V_{\text{IN}} &= V_{\text{OUT}(\text{S})} + 1.0 \text{ V}, \\ 1 \text{ mA} \leq I_{\text{OUT}} \leq 150 \text{ m}. \end{split}$		-	15	40	mV	1, 2
Output voltage temperature coefficient ^{*4}	$\frac{\Delta V_{OUT}}{\Delta Ta \bullet V_{OUT}}$	$\label{eq:VIN} \begin{split} V_{IN} &= V_{OUT(S)} + 1.0 \ V, \\ -40^\circ C \leq Ta \leq + 85^\circ C \end{split}$	_	±100	_	ppm/°C	1, 2	
Current consumption during operation (2 circuits)	I _{SS}	V _{IN} = 5.5 V, ON / OF no load	F pin = ON,	-	78	116	μA	3
Current consumption during operation (per circuit)	I _{SS1}	$\label{eq:VIN} \begin{split} V_{\text{IN}} &= V_{\text{OUT}(\text{S})} + 1.0 \text{ V},\\ \text{no load} \end{split}$	ON / OFF pin = ON,	-	39	58	μA	3
Current consumption during power-off	I _{SS2}	$V_{IN} = V_{OUT(S)} + 1.0 V,$ no load	ON / OFF pin = OFF,	-	0.1	1.0	μΑ	3
Input voltage	V _{IN}		-	1.5	-	5.5	V	-
ON / OFF pin input voltage "H"	V _{SH}	$V_{IN} = V_{OUT(S)} + 1.0 \text{ V},$	$R_L = 1.0 \text{ k}\Omega$	1.0	_	-	V	6, 7
ON / OFF pin input voltage "L"	V _{SL}	$V_{IN} = V_{OUT(S)} + 1.0 \text{ V},$	1	_	_	0.25	V	6, 7
ON / OFF pin	leu	V _{IN} = 5.5 V,	A / B / C type (with constant current source pull-down)	0.15	0.30	0.60	μA	6, 7
input current "H"	I _{SH}	$V_{ON/OFF} = 5.5 V$	D / E / F type (without constant current source pull-down)	-0.1	-	0.1	μΑ	6, 7
ON / OFF pin input current "L"	I _{SL}	$V_{IN} = 5.5 \text{ V}, V_{ON/OFF} = 0 \text{ V}$		-0.1	_	0.1	μA	6, 7
		$V_{IN} = V_{OUT(S)} + 1.0 V,$	$1.0~V \leq V_{OUT(S)} \leq 2.0~V$	-	75	_	dB	8, 9
Ripple rejection	RR	f = 1.0 kHz, $\Delta V_{rip} = 0.5$ Vrms,	$2.0 \text{ V} < \text{V}_{\text{OUT(S)}} \leq 3.0 \text{ V}$	-	72	-	dB	8, 9
		I _{OUT} = 30 mA	$3.0~V < V_{OUT(S)} \leq 3.6~V$	I	70	-	dB	8, 9
Short-circuit current	I _{short}		ON / OFF pin = ON,	_	40	_	mA	4, 5

Table 10 (1 / 2)

				(Ta = +)	25°C unl	ess other	wise sp	ecified)
Item	Symbol		Condition	Min.	Тур.	Max.	Unit	Test Circuit
Thermal shutdown detection temperature	T _{SD}	Junction tempe	Junction temperature		160	-	°C	-
Thermal shutdown release temperature	T _{SR}	Junction tempe	rature	-	130	-	°C	-
Discharge shunt			VOUT2 pin of C / F type (with delay function)	_	12	_	Ω	4, 5
resistance during power-off (With discharge shunt function)	R _{LOW}	V _{IN} = 5.5 V, V _{OUT} = 0.1 V	VOUT1 pin of C / F type (with delay function) B / E type (without delay function)	_	50	_	Ω	4, 5
Delay time ^{*6} (C / F type only)	t _{DELAY}	$ \begin{split} &V_{\text{IN}} \geq V_{\text{OUT(S)}} + 1.0 \text{ V, ON / OFF1 pin and} \\ &O\text{N / OFF2 pin are set to ON simultaneously,} \\ &R_L = 1.0 \text{ k}\Omega, C_{L1}, C_{L2} = 0.22 \mu\text{F} \end{split} $		50	100	_	μs	10

Table 10 (2 / 2)

*1. V_{OUT(S)}: Set output voltage

V_{OUT(E)}: Actual output voltage

Output voltage when fixing I_{OUT} (= 30 mA) and inputting $V_{OUT(S)}$ + 1.0 V

*2. The output current at which the output voltage becomes 95% of V_{OUT(E)} after gradually increasing the output current.

*3. $V_{drop} = V_{IN1} - (V_{OUT3} \times 0.98)$

 V_{OUT3} is the output voltage when $V_{IN} = V_{OUT(S)} + 1.0$ V and $I_{OUT} = 100$ mA.

 V_{IN1} is the input voltage at which the output voltage becomes 98% of V_{OUT3} after gradually decreasing the input voltage.

*4. A change in the temperature of the output voltage [mV/°C] is calculated using the following equation.

$$\frac{\Delta V_{OUT}}{\Delta Ta} \left[mV/^{\circ}C \right]^{*1} = V_{OUT(S)} \left[V \right]^{*2} \times \frac{\Delta V_{OUT}}{\Delta Ta \bullet V_{OUT}} \left[ppm/^{\circ}C \right]^{*3} \div 1000$$

- *1. Change in temperature of output voltage
- *2. Set output voltage
- *3. Output voltage temperature coefficient

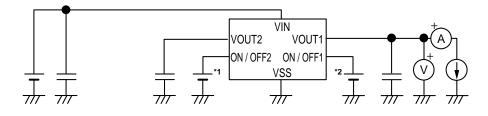
*5. The output current can be at least this value.

Due to restrictions on the package power dissipation, this value may not be satisfied. Attention should be paid to the power dissipation of the package when the output current is large.

This specification is guaranteed by design.

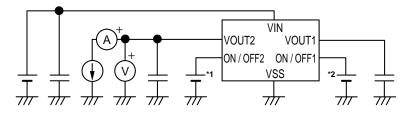
*6. Delay time shows the time period from when VOUT1 pin voltage reaches 50% of the set output voltage until VOUT2 pin voltage reaches 50% of the set output voltage, when the ON / OFF1 pin and the ON / OFF2 pin are set to ON simultaneously. Refer to "8. Delay function (S-13D1 Series C / F type)" in "■ Operation" for details.

Test Circuits



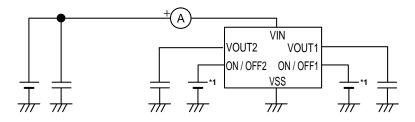
- *1. Set to OFF
- *2. Set to ON

Figure 11 Test Circuit 1



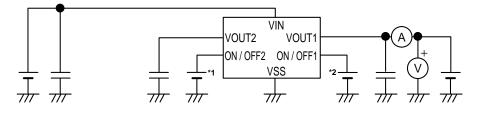
- *1. Set to ON
- *2. Set to OFF (set to ON in case of C / F type)





*1. Set to V_{IN} or GND

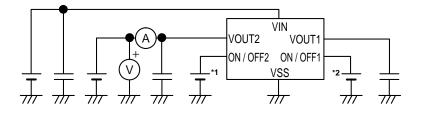




*1. Set to OFF

*2. Set to V_{IN} or GND

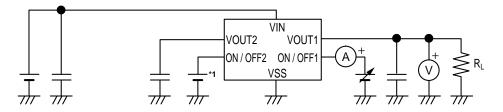
Figure 14 Test Circuit 4



*1. Set to V_{IN} or GND

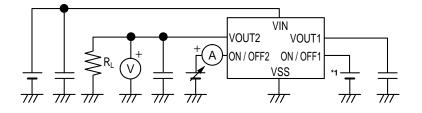
*2. Set to OFF (set to ON in case of C / F type)





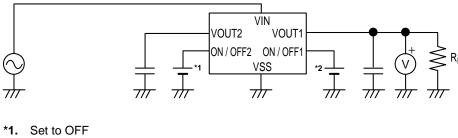
*1. Set to OFF

Figure 16 Test Circuit 6



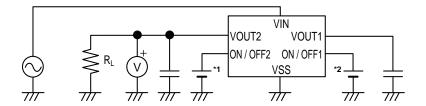
*1. Set to OFF (set to ON in case of C / F type)

Figure 17 Test Circuit 7



*2. Set to ON

Figure 18 Test Circuit 8



*1. Set to ON

*2. Set to OFF (set to ON in case of C / F type)

Figure 19 Test Circuit 9

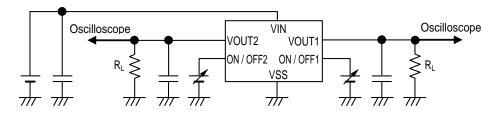
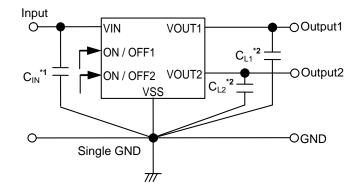


Figure 20 Test Circuit 10

Standard Circuit



- *1. C_{IN} is a capacitor for stabilizing the input.
- *2. A ceramic capacitor of 0.22 μF or more can be used as C_{L1} and $C_{L2}.$

Figure 21

Caution The above connection diagram and constants will not guarantee successful operation. Perform thorough evaluation using the actual application to set the constants.

Condition of Application

Caution Generally a series regulator may cause oscillation, depending on the selection of external parts. Confirm that no oscillation occurs in the application for which the above capacitors are used.

■ Selection of Input and Output Capacitors (C_{IN}, C_{L1}, C_{L2})

The S-13D1 Series requires an output capacitor between the VOUT pin and the VSS pin for phase compensation. Operation is stabilized by a ceramic capacitor with an output capacitance of 0.22 μ F or more over the entire temperature range. When using an OS capacitor, a tantalum capacitor, or an aluminum electrolytic capacitor, the capacitance must be 0.22 μ F or more.

The value of the output overshoot or undershoot transient response varies depending on the value of the output capacitor. The required capacitance of the input capacitor differs depending on the application.

The recommended capacitance for an application is $C_{IN} \ge 0.22 \ \mu\text{F}$, $C_{L1} \ge 0.22 \ \mu\text{F}$, $C_{L2} \ge 0.22 \ \mu\text{F}$; however, when selecting the output capacitor, perform sufficient evaluation, including evaluation of temperature characteristics, on the actual device.

Explanation of Terms

1. Low dropout voltage regulator

This voltage regulator has the low dropout voltage due to its built-in low on-resistance transistor.

2. Output voltage (VOUT)

The accuracy of the output voltage is ensured at $\pm 1.0\%$ or $\pm 15 \text{ mV}^{*1}$ under the specified conditions of fixed input voltage^{*2}, fixed output current, and fixed temperature.

- *1. When V_{OUT} < 1.5 V: ±15 mV, When $V_{OUT} \ge 1.5$ V: ±1.0%
- *2. Differs depending on the product.
- Caution If the above conditions change, the output voltage value may vary and exceed the accuracy range of the output voltage. Refer to "■ Electrical Characteristics (per Circuit)" and "■ Characteristics (Typical Data) (per Circuit)" for details.

3. Line regulation
$$\left(\frac{\Delta V_{OUT1}}{\Delta V_{IN} \bullet V_{OUT}}\right)$$

Indicates the dependency of the output voltage on the input voltage. That is, the values show how much the output voltage changes due to a change in the input voltage with the output current remaining unchanged.

4. Load regulation (ΔV_{OUT2})

Indicates the dependency of the output voltage on the output current. That is, the values show how much the output voltage changes due to a change in the output current with the input voltage remaining unchanged.

5. Dropout voltage (V_{drop})

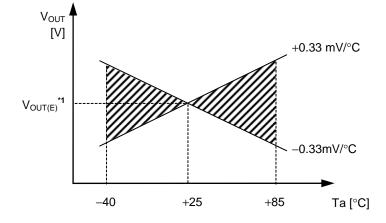
Indicates the difference between input voltage (V_{IN1}) and the output voltage when; decreasing input voltage (V_{IN}) gradually until the output voltage has dropped out to the value of 98% of output voltage (V_{OUT3}), which is at $V_{IN} = V_{OUT(S)} + 1.0 \text{ V}.$

 $V_{drop} = V_{IN1} - (V_{OUT3} \times 0.98)$

6. Output voltage temperature coefficient $\left(\frac{\Delta V_{OUT}}{\Delta Ta \bullet V_{OUT}}\right)$

The shaded area in **Figure 22** is the range where V_{OUT} varies in the operation temperature range when the output voltage temperature coefficient is $\pm 100 \text{ ppm}/^{\circ}\text{C}$.

Example of S-13D1B3333 typ. product



*1. $V_{OUT(E)}$ is the value of the output voltage measured at Ta = +25°C.

Figure 22

A change in the temperature of the output voltage [mV/°C] is calculated using the following equation.

$$\frac{\Delta V_{OUT}}{\Delta Ta} \left[mV/^{\circ}C \right]^{*1} = V_{OUT(S)} \left[V \right]^{*2} \times \frac{\Delta V_{OUT}}{\Delta Ta \bullet V_{OUT}} \left[ppm/^{\circ}C \right]^{*3} \div 1000$$

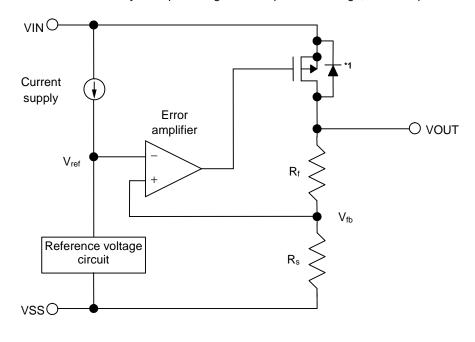
- ***1.** Change in temperature of output voltage
- *2. Set output voltage
- *3. Output voltage temperature coefficient

Operation

1. Basic operation

Figure 23 shows the block diagram of the S-13D1 Series.

The error amplifier compares the reference voltage (V_{ref}) with feedback voltage (V_{fb}), which is the output voltage resistance-divided by feedback resistors (R_s and R_f). It supplies the gate voltage necessary to maintain the constant output voltage which is not influenced by the input voltage and temperature change, to the output transistor.



*1. Parasitic diode



2. Output transistor

In the S-13D1 Series, a low on-resistance P-channel MOS FET is used as the output transistor.

Be sure that V_{OUT} does not exceed V_{IN} + 0.3 V to prevent the voltage regulator from being damaged due to reverse current flowing from the VOUT pin through a parasitic diode to the VIN pin, when the potential of V_{OUT} became higher than V_{IN} .

3. ON / OFF pin

This pin starts and stops the regulator.

When the ON / OFF pin is set to OFF level, the entire internal circuit stops operating, and the built-in P-channel MOS FET output transistor between the VIN pin and the VOUT pin is turned off, reducing current consumption significantly. Note that the current consumption increases when a voltage of 0.3 V to $V_{IN} - 0.3$ V is applied to the ON / OFF pin. The ON / OFF pin is configured as shown in **Figure 24** and **Figure 25**.

3.1 S-13D1 Series A / B / C type

The ON / OFF pin is internally pulled down to the VSS pin in the floating status, so the VOUT pin is set to the V_{SS} level.

3. 2 S-13D1 Series D / E / F type

The ON / OFF pin is not internally pulled down to the VSS pin, so do not use it in the floating status. When not using the ON / OFF pin, connect the pin to the VIN pin.

Table 11				
Product Type	ON / OFF Pin	Internal Circuit	VOUT Pin Voltage	Current Consumption
A/B/C/D/E/F	"H": ON	Operate	Set value	* 1 ا _{SS1}
A/B/C/D/E/F	"L": OFF	Stop	V _{SS} level	I _{SS2}

*1. Note that the IC's current consumption increases as much as current flows into the constant current of 0.3 μA typ. when the ON / OFF pin is connected to VIN pin and the S-13D1 Series A / B / C type is operating (refer to Figure 24).

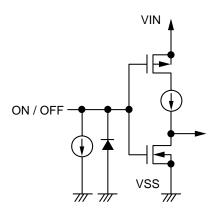
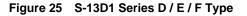


Figure 24 S-13D1 Series A / B / C Type



4. Discharge shunt function (S-13D1 Series B / C / E / F type)

The S-13D1 Series B / C / E / F type has a built-in discharge shunt circuit to discharge the output capacitance. The output capacitance is discharged as follows so that the VOUT pin reaches the V_{SS} level.

- (1) The ON / OFF pin is set to OFF level.
- (2) The output transistor is turned off.
- (3) The discharge shunt circuit is turned on.
- (4) The output capacitor discharges.

Since the S-13D1 Series A / D type does not have a discharge shunt circuit, the VOUT pin is set to the V_{SS} level through several hundred k Ω internal divided resistors between the VOUT pin and the VSS pin. The S-13D1 Series B / C / E / F type allows the VOUT pin to reach the V_{SS} level rapidly due to the discharge shunt circuit.

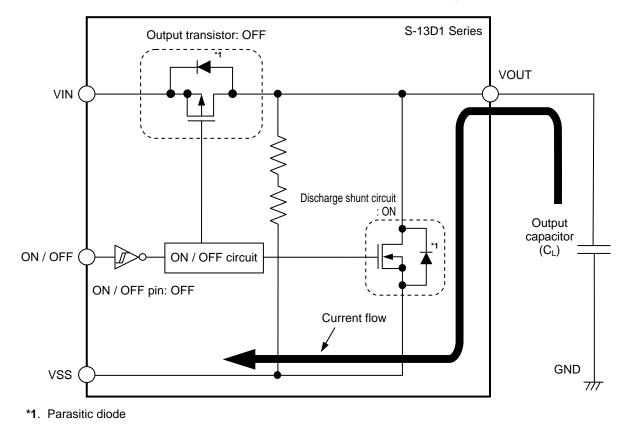
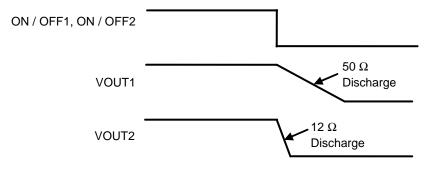


Figure 26

Moreover, C / F type in the S-13D1 Series, if the ON / OFF1 pin and the ON / OFF2 pin are set to OFF simultaneously, the discharge shunt on-resistance connected with the VOUT2 pin is reduced in order to make it easy for VOUT2 pin voltage to fall previously.

	Table 12
Product Type	Discharge Shunt ON-resistance (V_{IN} = 5.5 V, V_{OUT} = 0.1 V)
VOUT2 pin of C / F type	12 Ω
VOUT1 pin of C / F type, and B / E type	50 Ω





5. Constant current source pull-down (S-13D1 Series A / B / C type)

The ON / OFF pin is internally pulled down to the VSS pin in the floating status, so the VOUT pin is set to the V_{SS} level.

Note that the IC's current consumption increases as much as current flows into the constant current of 0.3 μ A typ. when the ON / OFF pin is connected to the VIN pin and the S-13D1 Series A / B / C type is operating.

6. Overcurrent protection circuit

The S-13D1 Series includes an overcurrent protection circuit which has the characteristics shown in "1. Output voltage vs. Output current (When load current increases) (Ta = $+25^{\circ}$ C)" in "**■** Characteristics (Typical Data) (per Circuit)", in order to protect the output transistor against an excessive output current and short circuiting between the VOUT pin and the VSS pin. The current when the output pin is short-circuited (I_{short}) is internally set at approx. 40 mA typ., and the normal value is restored for the output voltage, if releasing a short circuit once.

Caution This overcurrent protection circuit does not work as for thermal protection. If this IC long keeps short circuiting inside, pay attention to the conditions of input voltage and load current so that, under the usage conditions including short circuit, the loss of the IC will not exceed power dissipation of the package.

7. Thermal shutdown circuit

The S-13D1 Series has a thermal shutdown circuit to protect the device from damage due to overheat. When the junction temperature rises to 160°C typ., the thermal shutdown circuit operates to stop regulating. When the junction temperature drops to 130°C typ., the thermal shutdown circuit is released to restart regulating.

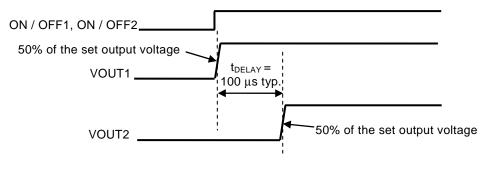
Due to self-heating of the S-13D1 Series, if the thermal shutdown circuit starts operating, it stops regulating so that the output voltage drops. When regulation stops, the S-13D1 Series does not itself generate heat and the IC's temperature drops. When the temperature drops, the thermal shutdown circuit is released to restart regulating, thus the S-13D1 Series generates heat again. Repeating this procedure makes the waveform of the output voltage into a pulse-like form. Stop or restart of regulation continues unless decreasing either or both of the input voltage and the output current in order to reduce the internal power consumption, or decreasing the ambient temperature.

Table 13					
Thermal Shutdown Circuit	VOUT Pin Voltage				
Operate: 160°C typ. ^{*1}	V _{SS} level				
Release: 130°C typ. ^{*1}	Set value				

***1.** Junction temperature

8. Delay function (S-13D1 Series C / F type)

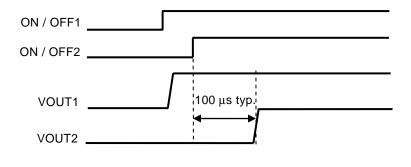
C / F type in the S-13D1 Series has a built-in delay function that sets the difference of rising time between channels. If the ON / OFF1 pin and the ON / OFF2 pin are set to ON simultaneously, VOUT2 pin voltage rises after the delay time ($t_{DELAY} = 100 \ \mu s \ typ$.).





8.1 In case ON / OFF2 pin is set to ON later

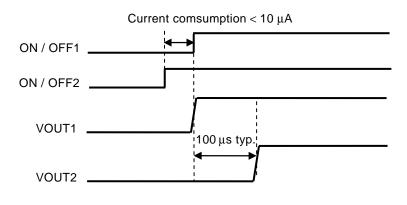
The VOUT1 pin voltage rises simultaneously when the ON / OFF1 pin is set to ON. After the ON / OFF2 pin is set to ON, VOUT2 pin voltage rises in 100 μ s typ.





8.2 In case ON / OFF2 pin is set to ON previously

VOUT2 pin voltage does no rise even if the ON / OFF2 pin is set to ON. VOUT1 pin voltage rises if the ON / OFF1 pin is set to ON. After VOUT1 pin voltage rises, VOUT2 pin voltage rises in 100 μ s typ.





Caution Note that the current consumption of less than 10 μ A flows during the time period from when the ON / OFF2 pin is set to ON until the ON / OFF1 pin is set to ON.

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Precautions

- Wiring patterns for the VIN pin, the VOUT pin and GND should be designed so that the impedance is low. When
 mounting the output capacitors between the VOUT pin and the VSS pin (C_{L1}, C_{L2}) and a capacitor for stabilizing the
 input between the VIN pin and the VSS pin (C_{IN}), the distance from the capacitors to these pins should be as short as
 possible.
- Note that generally the output voltage may increase when a series regulator is used at low load current (1.0 mA or less).
- Note that generally the output voltage may increase due to the leakage current from an output driver when a series regulator is used at high temperature.
- Note that the output voltage may increase due to the leakage current from an output driver even if the ON / OFF pin is at OFF level when a series regulator is used at a high temperature.
- Generally a series regulator may cause oscillation, depending on the selection of external parts. The following conditions are recommended for the S-13D1 Series. However, be sure to perform sufficient evaluation under the actual usage conditions for selection, including evaluation of temperature characteristics. Refer to "6. Example of equivalent series resistance vs. Output current characteristics (Ta = +25°C)" in "■ Reference Data (per Circuit)" for the equivalent series resistance (R_{ESR}) of the output capacitors.

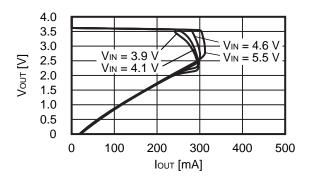
Input capacitor (C _{IN}):	0.22 µF or more
Output capacitors (C_{L1}, C_{L2}) :	0.22 μF or more

- The voltage regulator may oscillate when the impedance of the power supply is high and the input capacitance is small or an input capacitor is not connected.
- If the output capacitance is small, power supply's fluctuation and the characteristics of load fluctuation become worse. Sufficiently evaluate the output voltage's fluctuation with the actual device.
- Overshoot may occur in the output voltage momentarily if the voltage is rapidly raised at power-on or when the power supply fluctuates. Sufficiently evaluate the output voltage at power-on with the actual device.
- The application conditions for the input voltage, the output voltage, and the load current should not exceed the package power dissipation.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
- In determining the output current, attention should be paid to the output current value specified in **Table 10** in **"■ Electrical Characteristics (per Circuit)**" and footnote ***5** of the table.
- ABLIC Inc. claims no responsibility for any disputes arising out of or in connection with any infringement by products including this IC of patents owned by a third party.

■ Characteristics (Typical Data) (per Circuit)

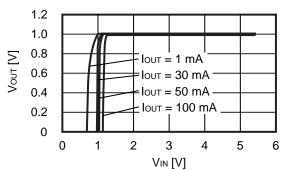
- 1. Output voltage vs. Output current (When load current increases) (Ta = +25°C)
- 1.1 V_{OUT} = 1.0 V 1.2 VIN = 1.5 V 1.0 0.8 Vout [V] Vin = 2.0 V VIN = 1.3 V 0.6 VIN = 3.0 V VIN = 5.5 V 0.4 0.2 0 0 100 200 300 400 500 IOUT [mA]

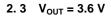
1.3 V_{OUT} = 3.6 V

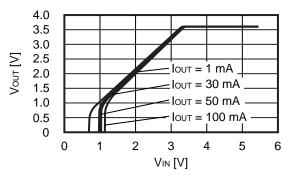


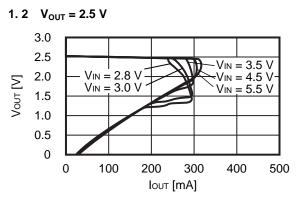
2. Output voltage vs. Input voltage (Ta = +25°C)

2.1 $V_{OUT} = 1.0 V$

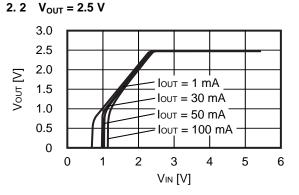




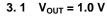


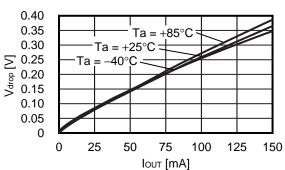


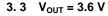
- **Remark** In determining the output current, attention should be paid to the following.
 - The minimum output current value and footnote *5 in Table 10 in "■ Electrical Characteristics (per Circuit)"
 - 2. The package power dissipation

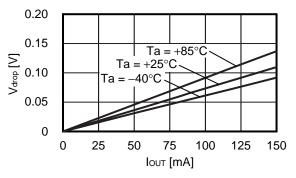


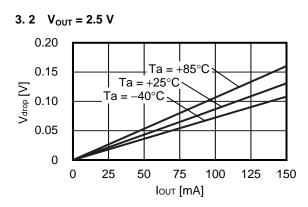
3. Dropout voltage vs. Output current



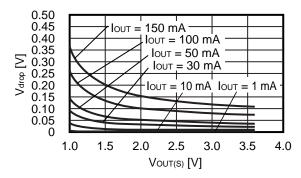






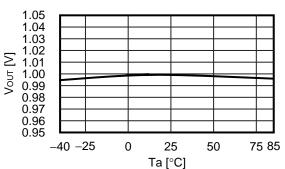


4. Dropout voltage vs. Set output voltage (Ta = +25°C)

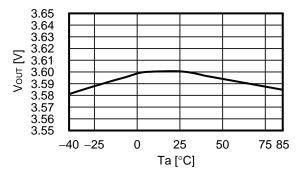


5. Output voltage vs. Ambient temperature

5.1 $V_{OUT} = 1.0 V$

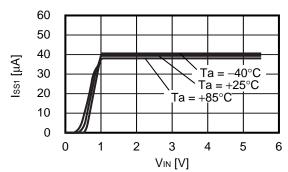


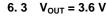


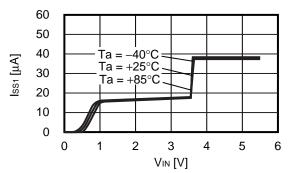


6. Current consumption vs. Input voltage

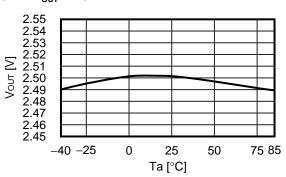




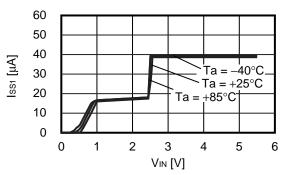




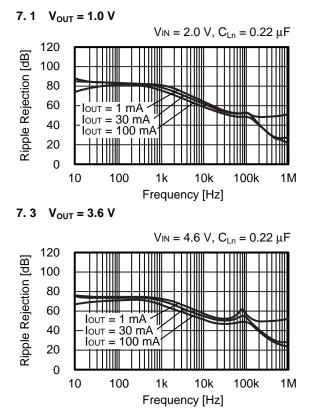




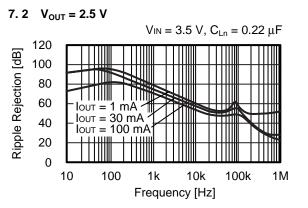
6. 2 $V_{OUT} = 2.5 V$



7. Ripple rejection (Ta = $+25^{\circ}$ C)



Remark C_{Ln} : Output capacitor set to the VOUTn pin externally (n = 1, 2)



Reference Data (per Circuit)

1. Transient response characteristics when input (Ta = +25°C)

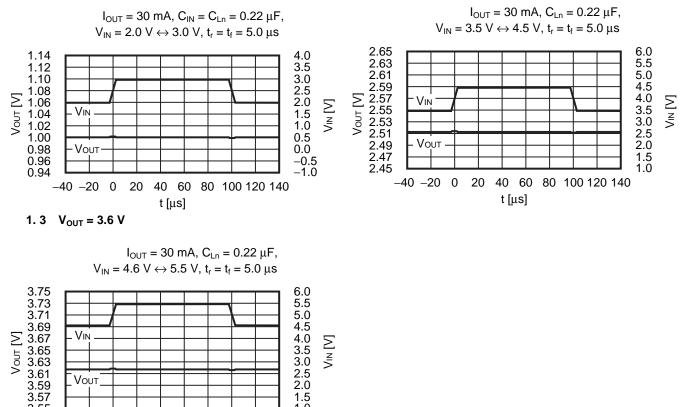
1.1 V_{OUT} = 1.0 V

Vout

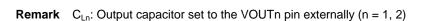
-40 -20 0

3.55

1.2 V_{OUT} = 2.5 V

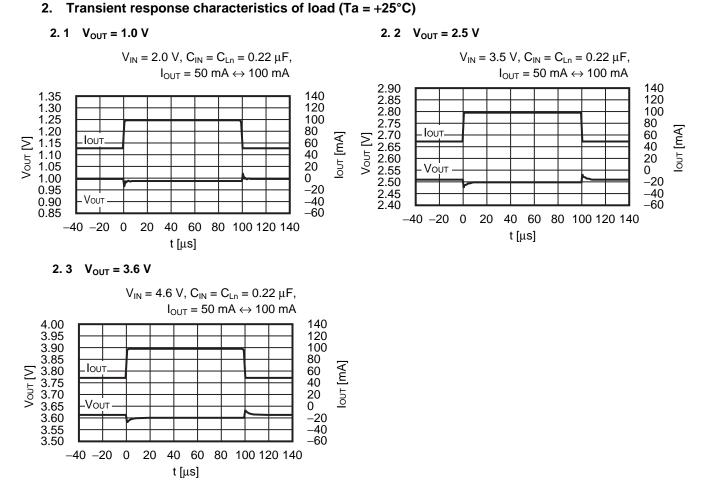


1.5 1.0



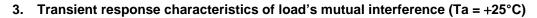
t [µs]

20 40 60 80 100 120 140

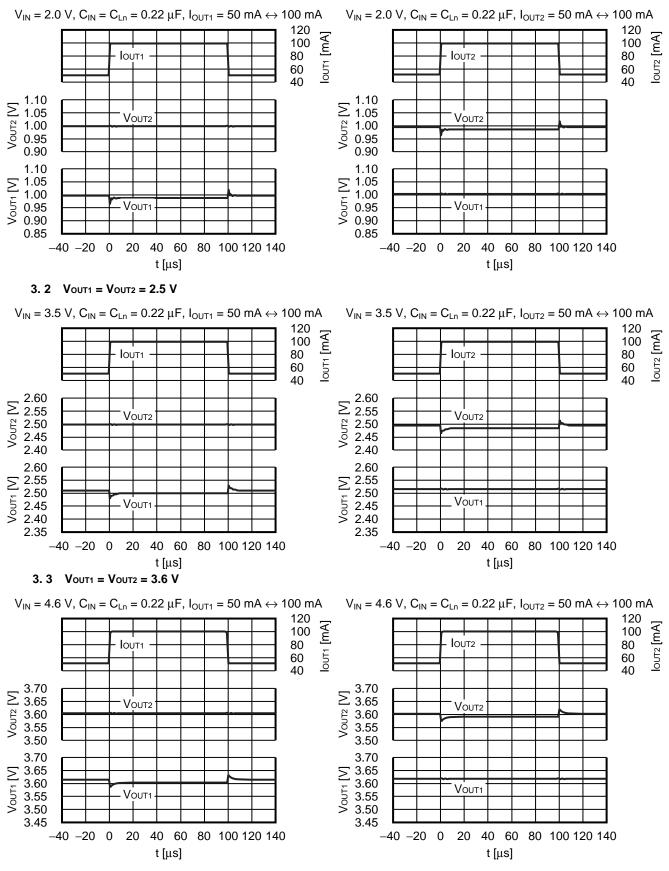


Remark C_{Ln}: Output capacitor set to the VOUTn pin externally (n = 1, 2)

5.5 V INPUT, 150 mA, 2-CIRCUIT VOLTAGE REGULATOR WITH DELAY FUNCTION Rev.1.4_00 S-13D1 Series



3. 1 VOUT1 = VOUT2 = 1.0 V



Remark C_{Ln} : Output capacitor set to the VOUTn pin externally (n = 1, 2)

4. Transient response characteristics of ON / OFF pin (Ta = +25°C)

4. 1 S-13D1 Series A / B / D / E type (without delay function)

4. 1. 1 V_{OUT} = 1.0 V

4. 1. 2 V_{OUT} = 2.5 V

6

5

4

3

2

1

0

-40

0

40

80

t [µs]

Vour [V]

 $V_{IN} = 3.5 \text{ V}, C_{IN} = C_{Ln} = 0.22 \ \mu\text{F}, I_{OUT} = 30 \text{ mA},$

 $V_{ON/OFF}$ = 0 V \rightarrow 3.5 V, t_r = 1.0 µs

VON/OFF

Vout

120 160 200 240

6

4

2

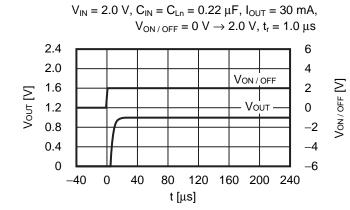
0

-2

-4

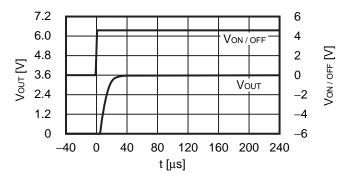
-6

Von / OFF [V]



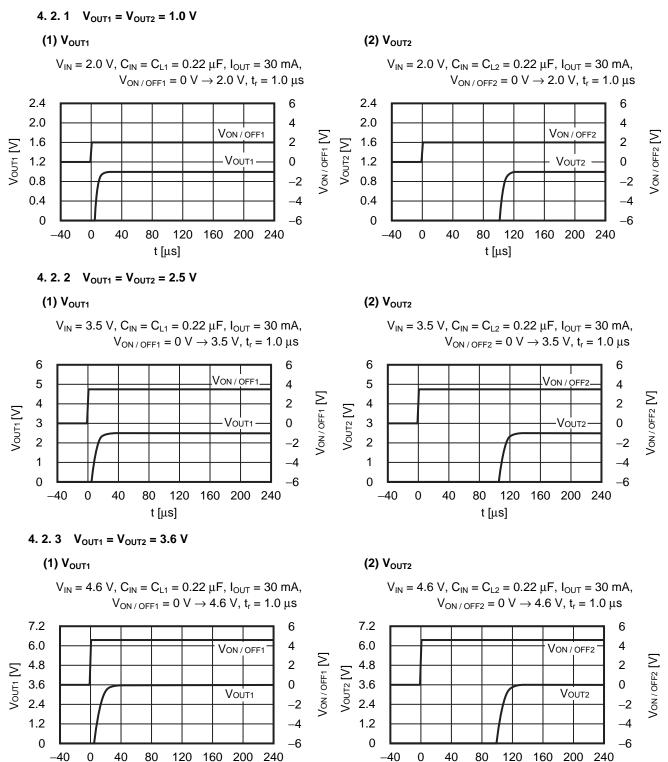
4.1.3 V_{OUT} = 3.6 V

 $V_{\text{IN}} = 4.6 \text{ V}, \text{ } \text{C}_{\text{IN}} = \text{C}_{\text{Ln}} = 0.22 \text{ } \mu\text{F}, \text{ } \text{I}_{\text{OUT}} = 30 \text{ mA}, \\ V_{\text{ON / OFF}} = 0 \text{ V} \rightarrow 4.6 \text{ V}, \text{ } \text{t}_{\text{r}} = 1.0 \text{ } \mu\text{s}$



Remark C_{Ln}: Output capacitor set to the VOUTn pin externally (n = 1, 2)

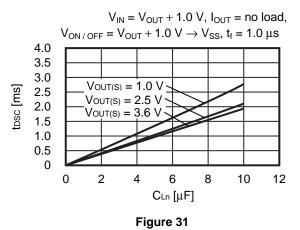
4. 2 S-13D1 Series C / F type (with delay function, when V_{ON/OFF1} and V_{ON/OFF2} are raised simultaneously)



t [µs]

t [µs]

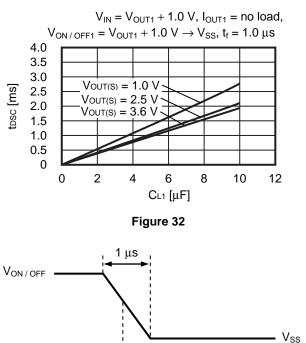
- 5. Output capacitance vs. Characteristics of discharge time (Ta = +25°C)
- 5.1 S-13D1 Series B / E type (with discharge shunt function, without delay funciton)
 - 5.1.1 V_{OUT}





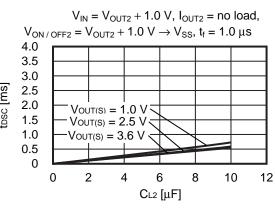
5. 2 S-13D1 Series C / F type (with discharge shunt function, with delay funciton)

5. 2. 1 V_{OUT1}













t_{DSC}

Remark C_{Ln} : Output capacitor set to the VOUTn pin externally (n = 1, 2)

$$\label{eq:VIN} \begin{split} V_{IN} = V_{OUT} + 1.0 \ V \\ V_{ON \, / \, OFF} = V_{OUT} + 1.0 \ V \rightarrow V_{SS} \end{split}$$

<u>--</u>V_{OUT} × 10%

VOUT

6. Example of equivalent series resistance vs. Output current characteristics ($Ta = +25^{\circ}C$)

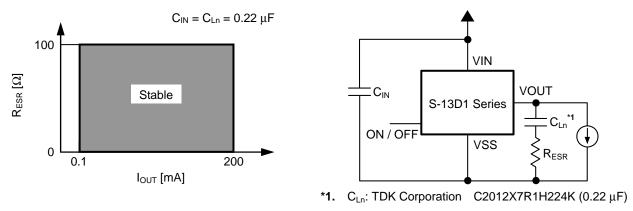
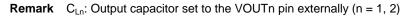


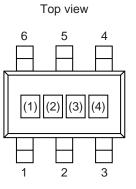
Figure 35

Figure 36



Marking Specifications

1. SOT-23-6



(1) to (3): (4):

: Product code (Refer to **Product name vs. Product code**) Lot number

Product name vs. Product code

1.1 S-13D1 Series B type

Product Name	Product Code		
Froduct Name	(1)	(2)	(3)
S-13D1B1218-M6T1U3	1	5	К
S-13D1B1528-M6T1U3	1	6	В
S-13D1B1812-M6T1U3	1	5	G
S-13D1B1815-M6T1U3	1	5	Н
S-13D1B1818-M6T1U3	1	5	L
S-13D1B1828-M6T1U3	1	5	Ν
S-13D1B1833-M6T1U3	1	6	А
S-13D1B2518-M6T1U3	1	5	J
S-13D1B2818-M6T1U3	1	5	F
S-13D1B2828-M6T1U3	1	5	0
S-13D1B2833-M6T1U3	1	5	Р
S-13D1B2J2J-M6T1U3	1	5	Q
S-13D1B3018-M6T1U3	1	5	А
S-13D1B3130-M6T1U3	1	5	D
S-13D1B3330-M6T1U3	1	5	С
S-13D1B3333-M6T1U3	1	5	В

1.2 S-13D1 Series C type

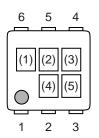
Product Name	Product Code		
Floduct Name	(1)	(2)	(3)
S-13D1C1218-M6T1U3	1	5	U
S-13D1C1528-M6T1U3	1	5	3
S-13D1C1818-M6T1U3	1	5	V
S-13D1C1828-M6T1U3	1	5	Х
S-13D1C1833-M6T1U3	1	5	2
S-13D1C2828-M6T1U3	1	5	Y
S-13D1C2833-M6T1U3	1	5	Z
S-13D1C2J2J-M6T1U3	1	5	1
S-13D1C3636-M6T1U3	1	5	S

1.3 S-13D1 Series D type

Product Name	Product Code		
Floduct Name	(1)	(2)	(3)
S-13D1D1218-M6T1U3	1	7	А
S-13D1D1528-M6T1U3	1	7	Н
S-13D1D1818-M6T1U3	1	7	В
S-13D1D1828-M6T1U3	1	7	С
S-13D1D1833-M6T1U3	1	7	G
S-13D1D2828-M6T1U3	1	7	D
S-13D1D2833-M6T1U3	1	7	Е
S-13D1D2J2J-M6T1U3	1	7	F

2. HSNT-6 (1212)

Top view



(1) to (3): Product code (Refer to Product name vs. Product code)(4), (5): Lot number

Product name vs. Product code

2.1 S-13D1 Series B type

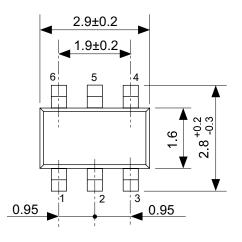
Product Name	Product Code		
	(1)	(2)	(3)
S-13D1B1218-A6T2U3	1	5	К
S-13D1B1528-A6T2U3	1	6	В
S-13D1B1812-A6T2U3	1	5	G
S-13D1B1815-A6T2U3	1	5	Н
S-13D1B1818-A6T2U3	1	5	L
S-13D1B1828-A6T2U3	1	5	Ν
S-13D1B1833-A6T2U3	1	6	А
S-13D1B2518-A6T2U3	1	5	J
S-13D1B2818-A6T2U3	1	5	F
S-13D1B2828-A6T2U3	1	5	0
S-13D1B2833-A6T2U3	1	5	Р
S-13D1B2J2J-A6T2U3	1	5	Q
S-13D1B3018-A6T2U3	1	5	А
S-13D1B3130-A6T2U3	1	5	D
S-13D1B3330-A6T2U3	1	5	С
S-13D1B3333-A6T2U3	1	5	В

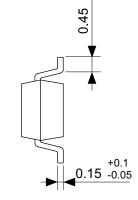
2.3 S-13D1 Series D type

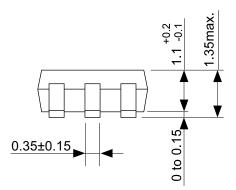
Product Name	Product Code		
Product Name	(1)	(2)	(3)
S-13D1D1218-A6T2U3	1	7	А
S-13D1D1528-A6T2U3	1	7	Н
S-13D1D1818-A6T2U3	1	7	В
S-13D1D1828-A6T2U3	1	7	С
S-13D1D1833-A6T2U3	1	7	G
S-13D1D2828-A6T2U3	1	7	D
S-13D1D2833-A6T2U3	1	7	Е
S-13D1D2J2J-A6T2U3	1	7	F

2. 2 S-13D1 Series C type

Product Name	Product Code		
Product Name	(1)	(2)	(3)
S-13D1C1218-A6T2U3	1	5	U
S-13D1C1528-A6T2U3	1	5	3
S-13D1C1818-A6T2U3	1	5	V
S-13D1C1828-A6T2U3	1	5	Х
S-13D1C1833-A6T2U3	1	5	2
S-13D1C2828-A6T2U3	1	5	Y
S-13D1C2833-A6T2U3	1	5	Z
S-13D1C2J2J-A6T2U3	1	5	1
S-13D1C3636-A6T2U3	1	5	S

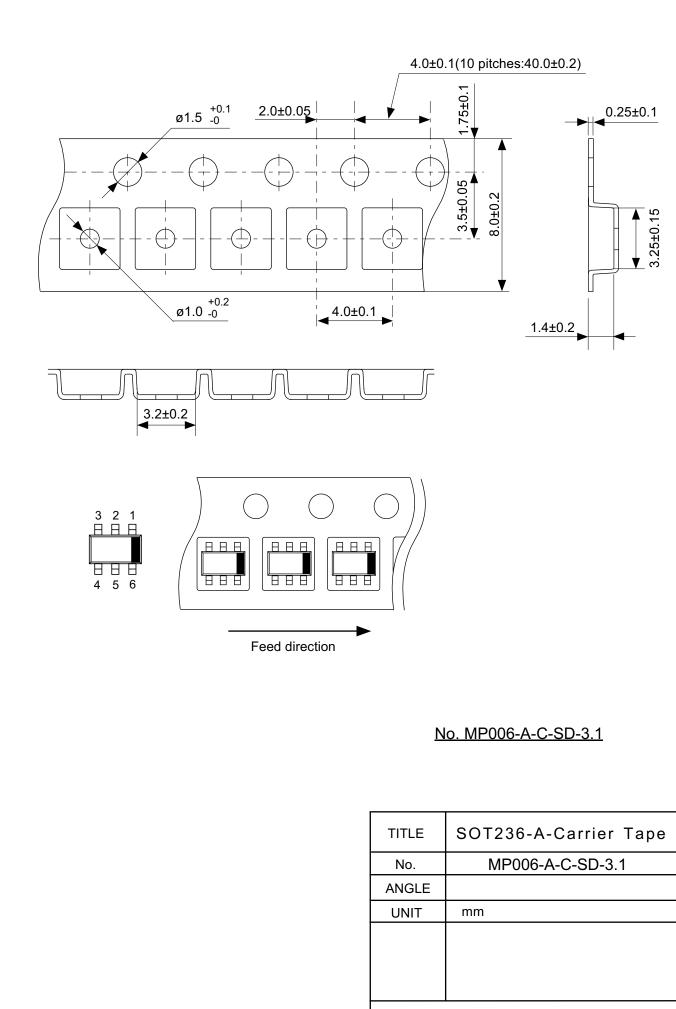




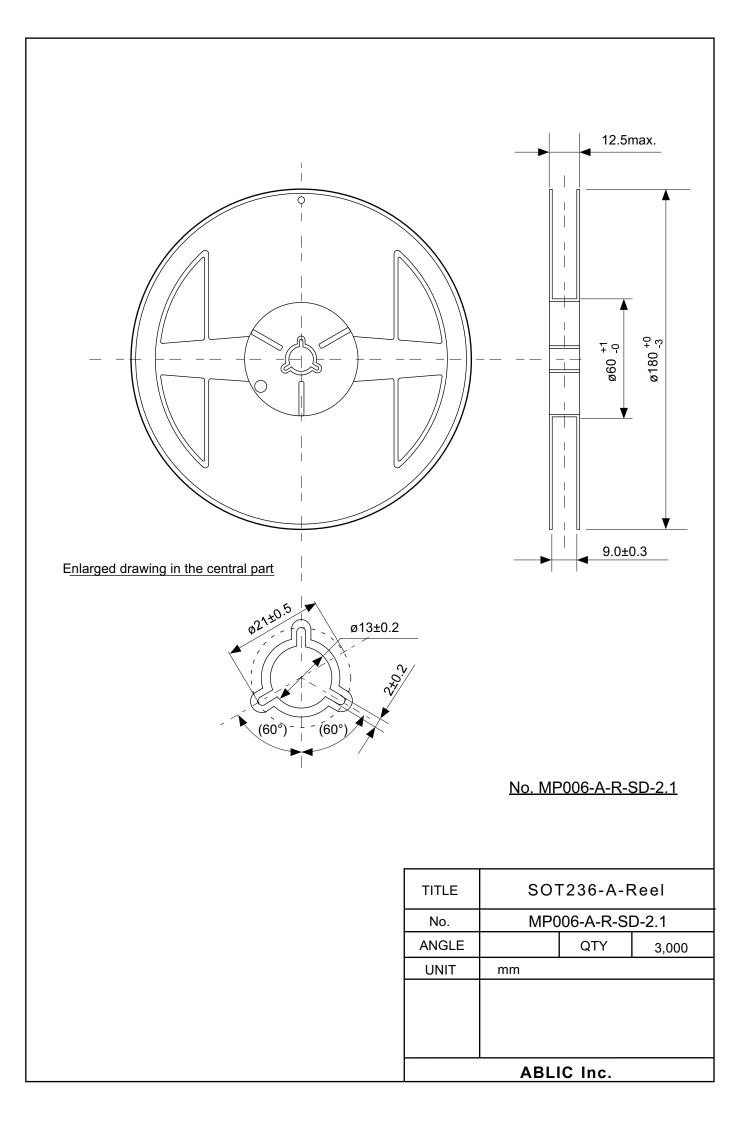


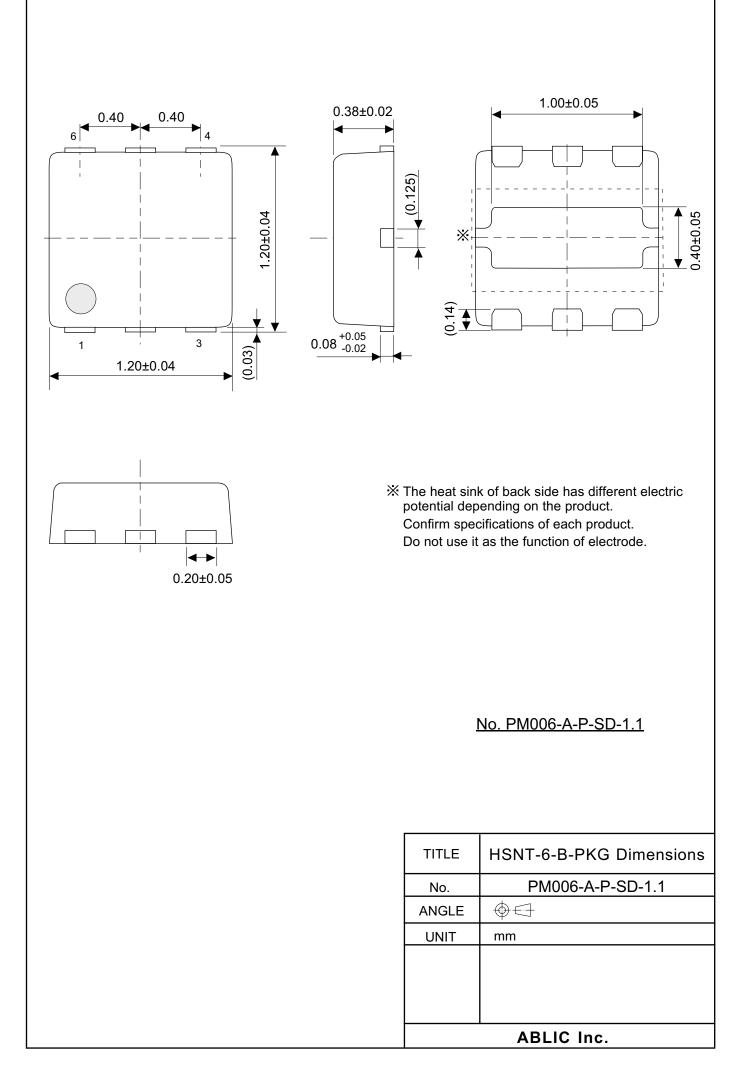
No. MP006-A-P-SD-2.1

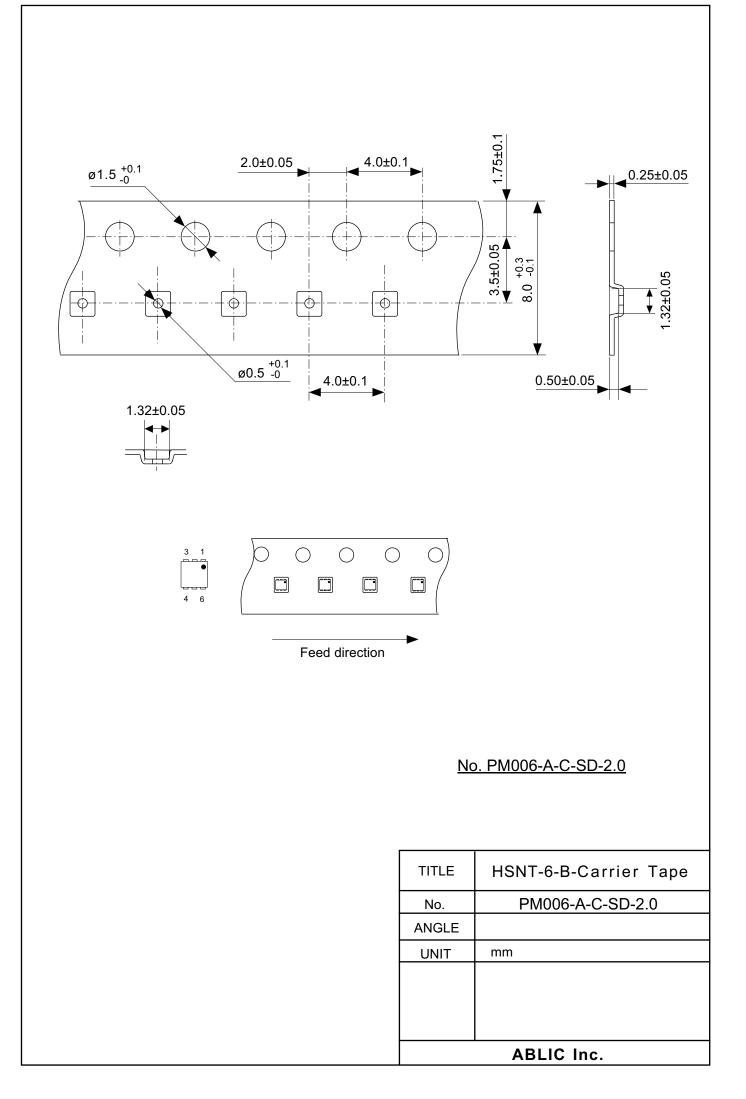
TITLE	SOT236-A-PKG Dimensions	
No.	MP006-A-P-SD-2.1	
ANGLE	\oplus	
UNIT	mm	
	ABLIC Inc.	

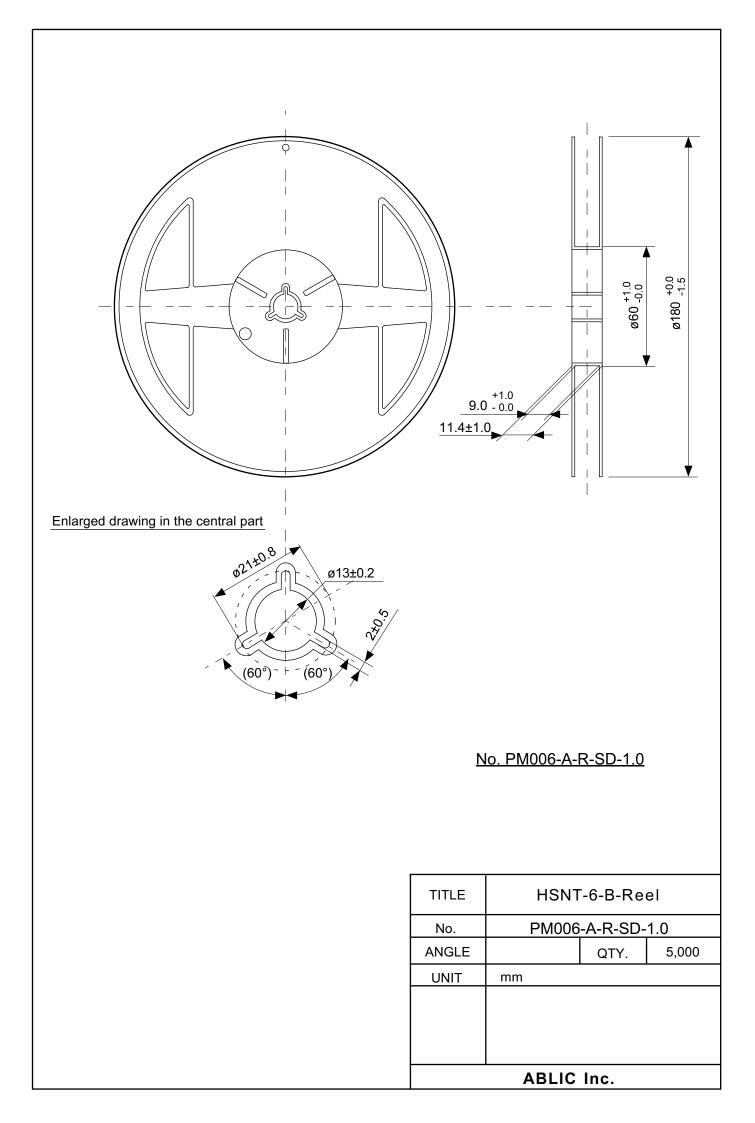


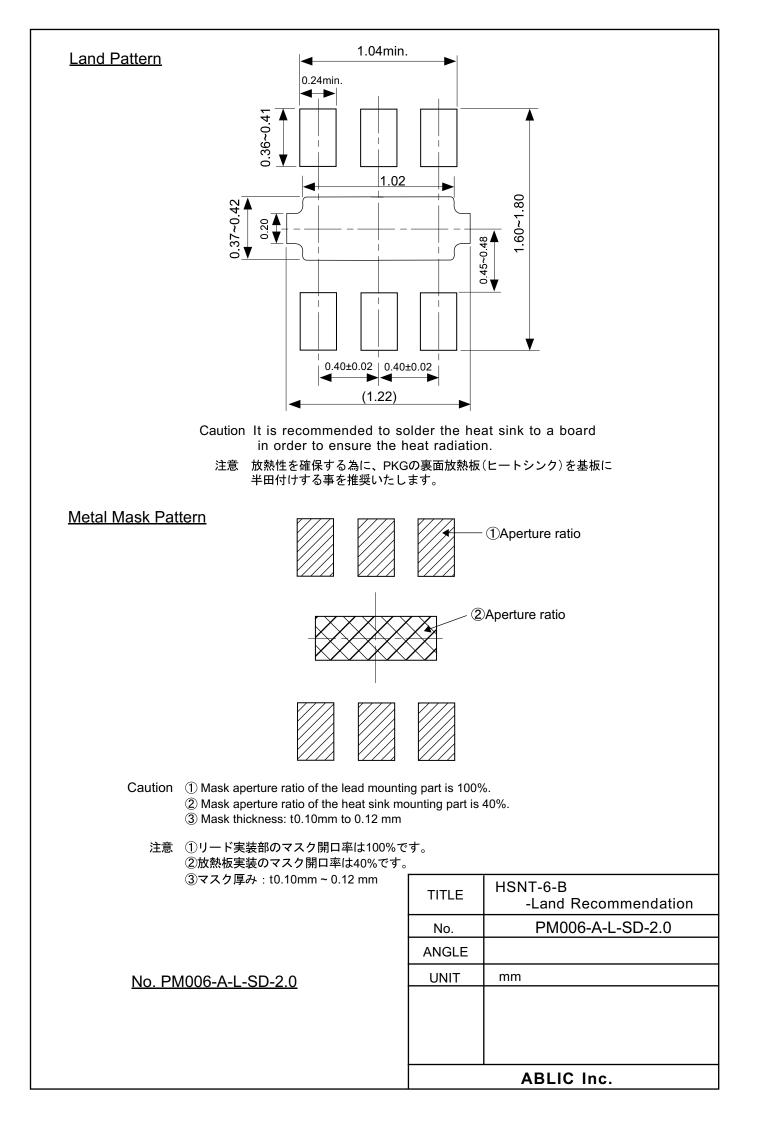
ABLIC Inc.











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2.4-2019.07